LTCC

High Pass Filter

50Ω 2400 to 2500 MHz

HPJC-252R+

Generic photo used for illustration purposes only

CASE STYLE: JC0603C-4

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost

Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500,1000, 3000

Features

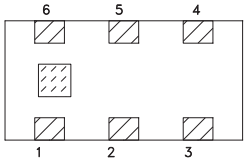
- Miniature size 0603
- High stop band rejections
- Low cost
- Aqueous washable

Applications

- ISM Band
- WLAN
- Bluetooth
- Zigbee

Block Diagram

Top View



Pad Connections

Input	1
Output	3
Ground	2,5
No Connection	4,6

Electrical Specifications at 25°C

Parameter		Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Insertion Loss[1]	2400 - 2500	—	1.0	1.4	dB
	VSWR	2400 - 2500	—	1.5	1.7	:1
Stop Band	Rejection Loss	500-1917	—	35	—	dB
		1917	18	25	—	

1. Tested on Evaluation Board TB-1025+

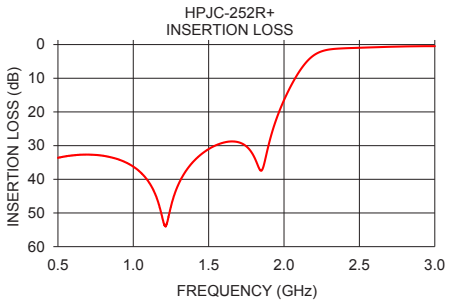
Maximum Ratings

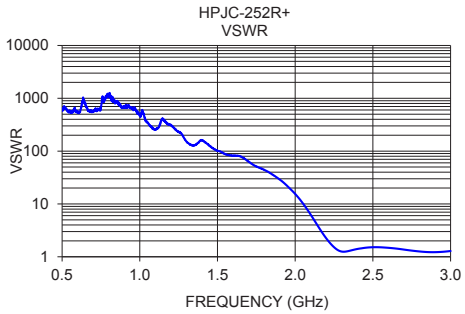
Operating Temperature	-40°C to 85°C
Storage Temperature[2]	-40°C to 85°C
RF Power Input[3]	2W at 25°C

2.Refer to product storage temperature after installation
Suggestion for T&R unused product storage condition:
+5 ~ +35 °C, Humidity 45~75%RH, 12 month Max
3. Derate linearly to 1W at 85°C.

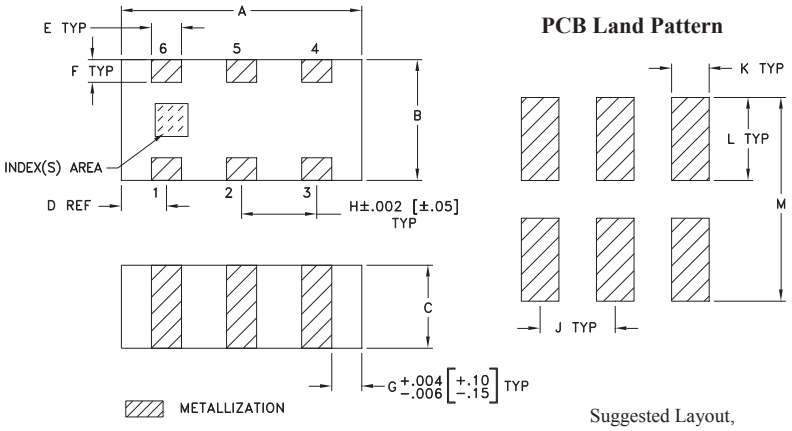
Typical Performance Data at 25°C

Frequency (GHz)	Insertion Loss (dB)	VSWR (:1)
0.50	33.63	589.33
1.00	36.24	467.00
1.50	31.02	100.87
1.917	26.58	26.60
2.00	16.47	15.45
2.30	1.46	1.25
2.40	1.10	1.40
2.45	1.02	1.48
2.50	0.95	1.52
2.60	0.80	1.48
3.00	0.47	1.29



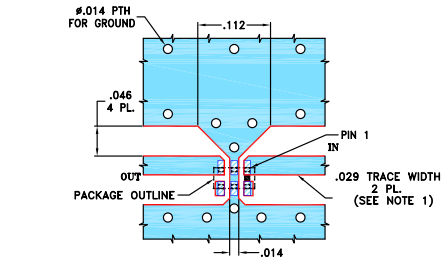


Outline Drawing



Suggested Layout,
Tolerance to be within .002

Evaluation Board MCL P/N: TB-1025+
Suggested PCB Layout (PL-553)



NOTES:
1. TRACE WIDTH IS SHOWN FOR FR4, GRADE IT-180TC (ITEQ CORP.) WITH DIELECTRIC THICKNESS .016±.0015. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Outline Dimensions (inch / mm)

A	B	C	D	E	F	G
.063	.032	.022	.012	.008	.006	.008
1.60	0.81	0.56	0.30	0.20	0.15	0.20

H	J	K	L	M		wt
.020	.020	.010	.022	0.053		grams
0.51	0.51	0.25	0.56	1.35		.005

Additional Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

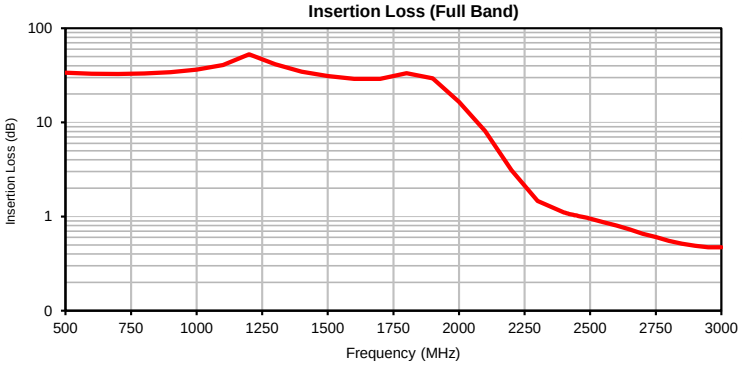
Ceramic High Pass Filter HPJC-252R+

Typical Performance Data

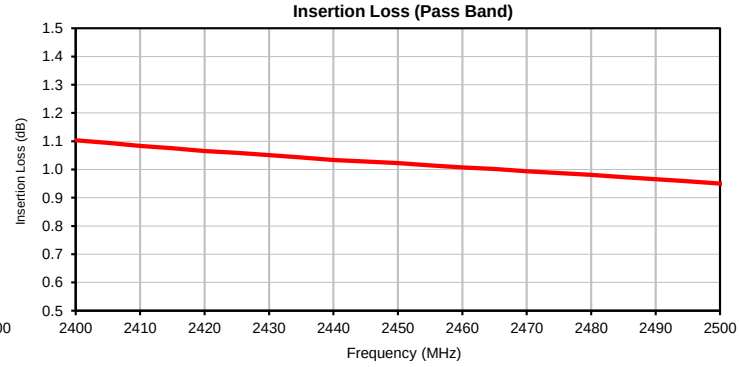
FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT VSWR (:1)	OUTPUT VSWR (:1)
500	33.63	351.20	589.33
600	32.88	573.19	534.64
700	32.67	584.98	482.40
800	33.02	1065.18	406.91
900	34.09	683.66	547.07
1000	36.24	467.00	421.04
1100	40.65	248.38	256.90
1200	52.85	175.39	308.31
1300	41.44	127.93	151.76
1400	34.66	104.63	161.11
1500	31.02	83.47	100.87
1600	29.09	66.92	81.30
1700	29.03	52.58	63.06
1800	33.20	40.28	44.57
1900	29.40	27.56	28.99
1917	26.58	25.49	26.60
2000	16.47	15.45	15.36
2100	8.08	6.25	6.08
2200	3.11	2.23	2.10
2300	1.46	1.25	1.09
2400	1.10	1.40	1.39
2405	1.09	1.41	1.40
2410	1.08	1.42	1.41
2415	1.07	1.43	1.42
2420	1.07	1.44	1.43
2425	1.06	1.44	1.44
2430	1.05	1.45	1.45
2435	1.04	1.46	1.46
2440	1.03	1.46	1.47
2445	1.03	1.47	1.47
2450	1.02	1.47	1.48
2455	1.01	1.47	1.49
2460	1.01	1.48	1.49
2465	1.00	1.48	1.50
2470	0.99	1.48	1.50
2475	0.99	1.49	1.50
2480	0.98	1.49	1.51
2485	0.97	1.49	1.51
2490	0.97	1.49	1.51
2495	0.96	1.49	1.52
2500	0.95	1.49	1.52
2550	0.87	1.47	1.51
2600	0.80	1.42	1.48
2650	0.73	1.36	1.43
2700	0.66	1.28	1.37
2750	0.61	1.21	1.31
2800	0.55	1.13	1.26
2850	0.52	1.07	1.23
2900	0.49	1.06	1.22
2950	0.47	1.11	1.24
3000	0.47	1.18	1.29

Typical Performance Curves

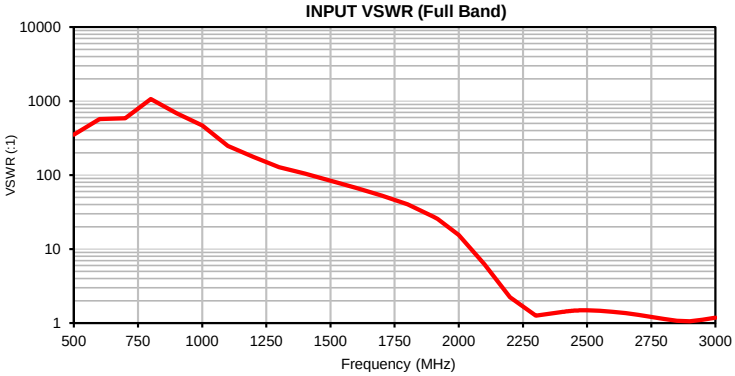
Insertion Loss (Full Band)



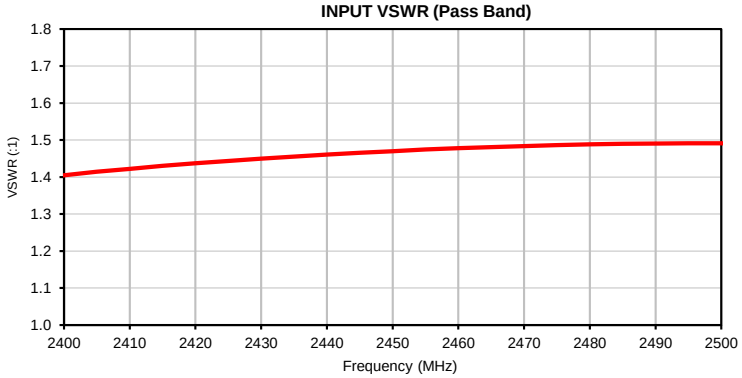
Insertion Loss (Pass Band)



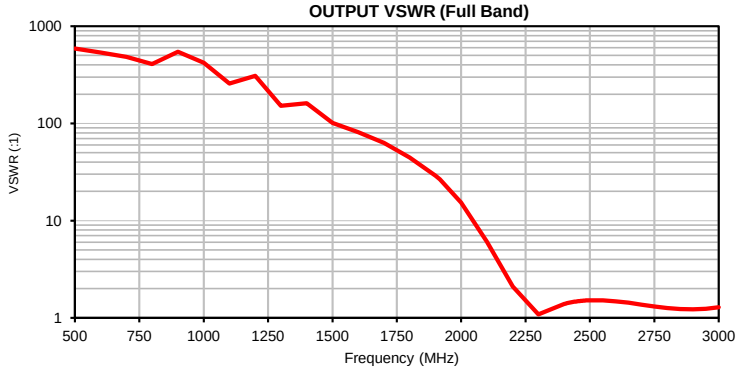
INPUT VSWR (Full Band)



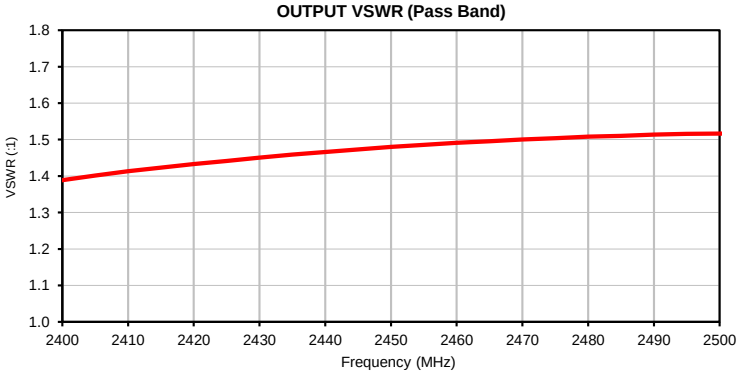
INPUT VSWR (Pass Band)



OUTPUT VSWR (Full Band)



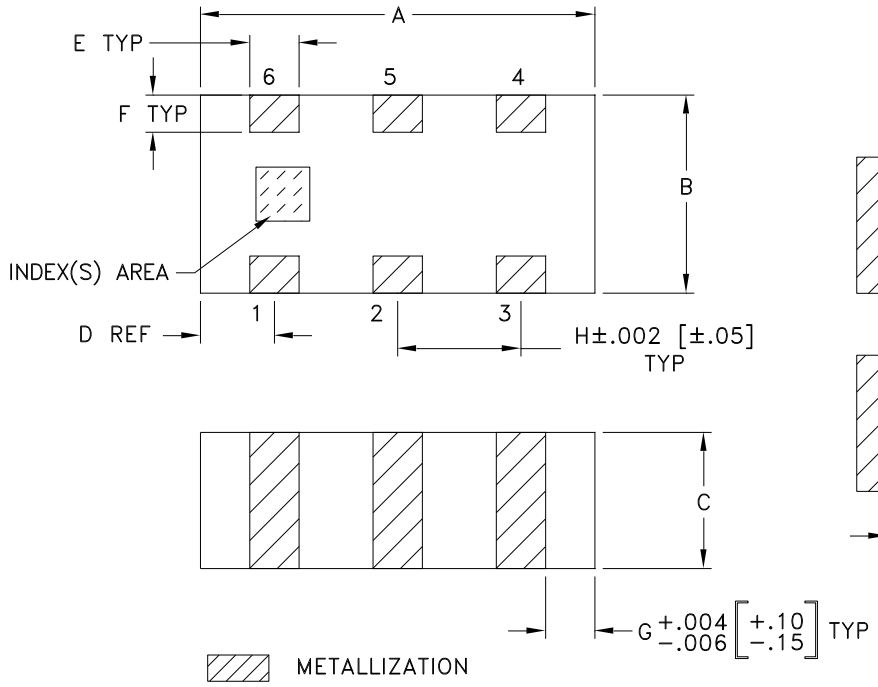
OUTPUT VSWR (Pass Band)



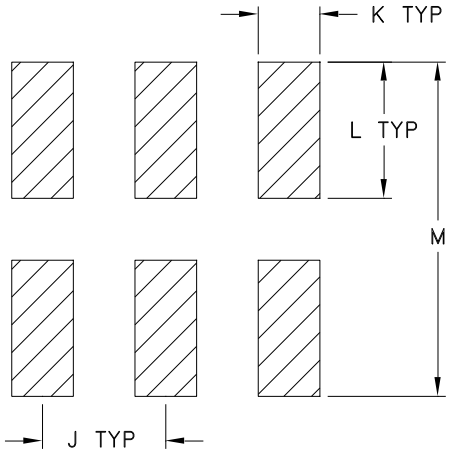
Case Style JC

Outline Dimensions

JC0603C-4



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
JC0603C-4	.063 (1.60)	.032 (0.80)	.022 (0.55)	.012 (0.30)	.008 (0.20)	.006 (0.15)	.008 (0.20)	.020 (0.50)	.020 (0.50)	.010 (0.25)	.022 (0.55)	.053 (1.35)	.005

Dimensions are in inches (mm). Tolerances: 3 Pl. ± .004

Notes:

1. Open style, ceramic base.
2. Termination finish:
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
3. - Line width should be designed to match 50 OHMS characteristic impedance, depending on PCB material & thickness.

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R

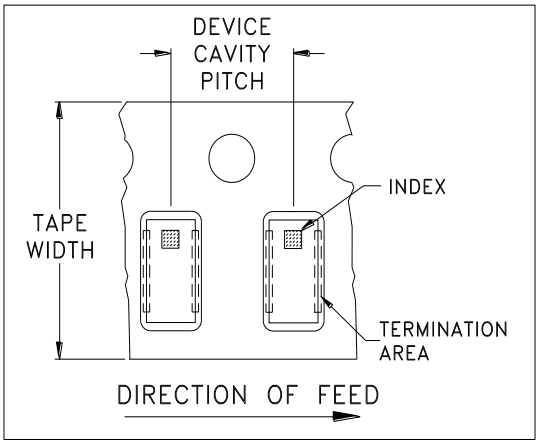


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

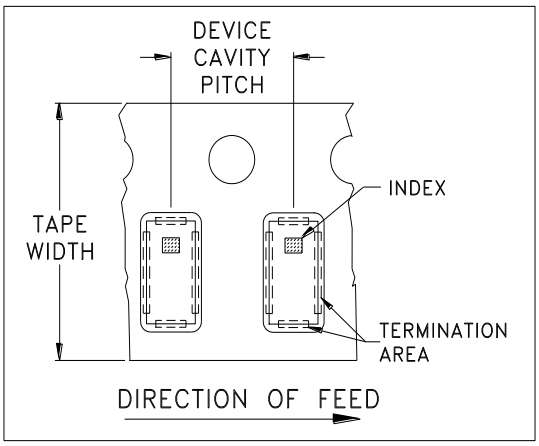


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

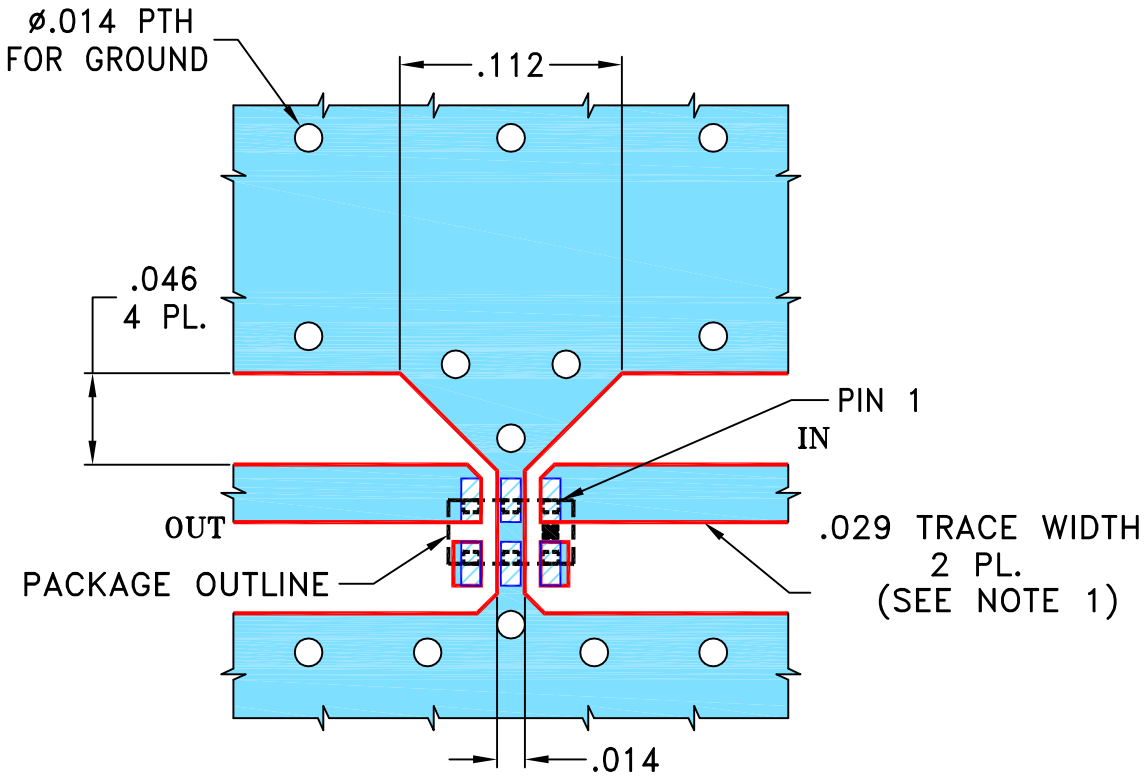
Go to: www.minicircuits.com/pages/pdfs/tape.pdf

Mini-Circuits®
INTERNET http://www.minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010
Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M168200	NEW RELEASE	05/31/18	NP	SL

SUGGESTED MOUNTING CONFIGURATION
FOR JC0603C-4 CASE STYLE, "06FL13" PIN CODE



NOTES:

1. TRACE WIDTH IS SHOWN FOR FR4, GRADE IT-180TC (ITEQ CORP.) WITH DIELECTRIC THICKNESS .016±.0015. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	NP	05/30/18
TOLERANCES ON:	CHECKED	GF	05/30/18
2 PL DECIMALS ±	APPROVED	SL	05/31/18
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

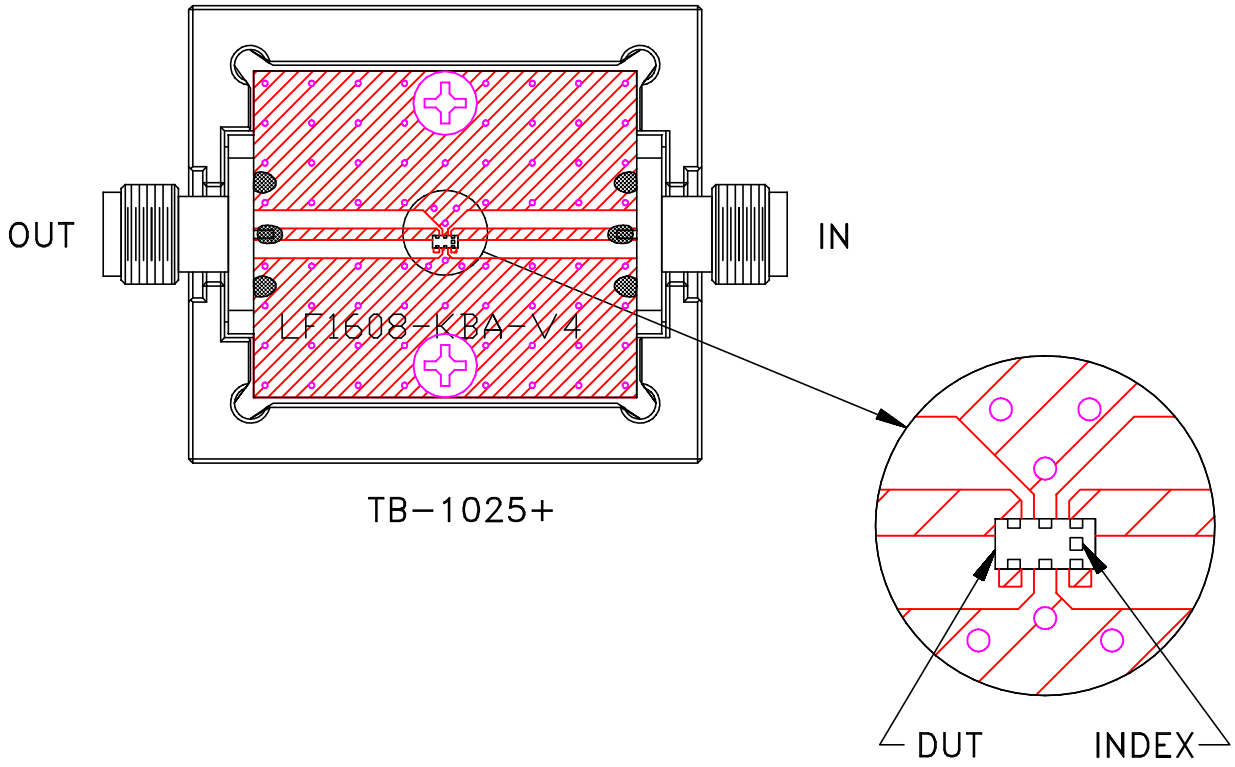
ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits®
13 Neptune Avenue
Brooklyn NY 11235

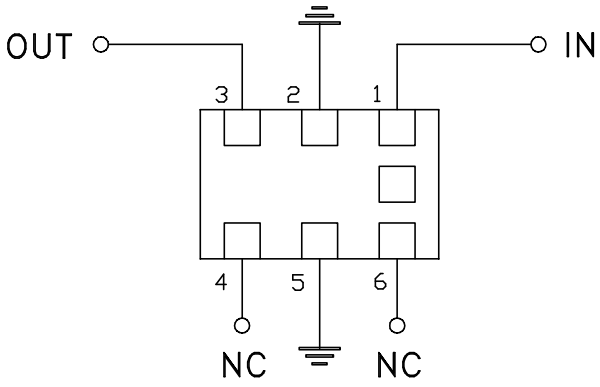
PL, 06FL13, JC0603C-4, TB-1025+

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-553	OR
FILE: 98PL553		SCALE: 10:1	SHEET: 1 OF 1

Evaluation Board and Circuit



TB-1025+



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: FR4 or equivalent,
   Dielectric Constant=4.5, Thickness=.016 inch.

Mini-Circuits®

Mini-Circuits

Environmental Specifications **ENV06T4**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-40° to 85° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process: 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2; Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A